

Global Silver Sintering Die Bonding Equipment Market Growth 2026-2032

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Abstracts

The global Silver Sintering Die Bonding Equipment market size is predicted to grow from US\$ 132 million in 2025 to US\$ 216 million in 2032; it is expected to grow at a CAGR of 7.3% from 2026 to 2032.

Silver sintering die bonding equipment refers to dedicated die placement and sintering bonding systems used in power semiconductor and high-reliability electronic packaging. By using silver sintering paste, silver sintering film or silver preforms under controlled temperature, pressure, time, atmosphere and placement accuracy, the equipment forms low-void, high-thermal-conductivity, high-electrical-conductivity and thermally robust solid-state interconnects between bare dies, power chips, clips, DTS structures, DBC/AMB substrates, leadframes or power module carriers. A typical system consists of die feeding, vision alignment, silver material transfer or placement, thermo-compression bonding, sintering chamber, closed-loop pressure control, temperature control, atmosphere protection, tooling, automated loading/unloading and process traceability modules. By configuration, it includes semi-automatic die bonding equipment, fully automatic die bonding equipment, offline silver sintering systems and inline silver sintering production systems. Major production bases are concentrated in China, Singapore, Germany, Italy, the Netherlands, Switzerland, Japan and the United States, with applications in SiC power modules, IGBT modules, automotive inverters, industrial drives, power supply modules, RF power devices and aerospace-grade high-reliability electronic packaging.

In 2025, global silver sintering die bonding equipment production reached approximately 170-205 units, with mainstream factory-gate FOB prices of about USD 650,000-850,000 per unit. Fully automatic inline tools, large-area multi-press-head systems for automotive-grade SiC power modules, and high-end models equipped with vacuum

assistance, atmosphere protection, process traceability and high-precision closed-loop pressure control were generally positioned at the upper end of the price range, while R&D, semi-automatic and offline systems were priced lower.

Global silver sintering die bonding equipment is becoming a key equipment category in the upgrade of power semiconductor packaging. Electric vehicle high-voltage platforms, 800V e-drive systems, SiC power modules, industrial inverters, photovoltaic inverters, energy storage PCS and high-reliability power systems are raising requirements for thermal conductivity, high-temperature endurance, thermal-cycle lifetime and long-term interconnect stability. These trends are driving silver sintering from a high-end qualification process toward scaled mass production. Compared with conventional soft soldering and certain conductive adhesive interconnects, silver sintering bonding offers advantages in high-temperature operation, low thermal resistance, low voiding and higher power density, expanding equipment demand from standalone sintering presses to integrated production-line solutions covering silver material placement, die bonding, pressure sintering, inline inspection and data traceability.

However, commercialization is still constrained by process complexity and long customer qualification cycles. Silver material format, die metallization, substrate surface condition, sintering pressure, temperature uniformity, atmosphere control and tooling design directly affect bond strength, void ratio and reliability, so end customers typically require extended process development, sample validation and automotive-grade qualification. Future competition will focus on large-area uniform pressure, independent multi-die pressing, high-accuracy placement, low-damage pressure control, vacuum or inert-atmosphere sintering, equipment stability, automation throughput and MES data connectivity. As SiC module capacity expands and power packaging localization accelerates, equipment supply chains in China, Europe, Japan and Singapore are expected to benefit from the long-term transition of power semiconductor packaging toward higher reliability, higher power density and intelligent manufacturing.

LP Information, Inc. (LPI) ' newest research report, the "Silver Sintering Die Bonding Equipment Industry Forecast" looks at past sales and reviews total world Silver Sintering Die Bonding Equipment sales in 2025, providing a comprehensive analysis by region and market sector of projected Silver Sintering Die Bonding Equipment sales for 2026 through 2032. With Silver Sintering Die Bonding Equipment sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US\$ millions of the world Silver Sintering Die Bonding Equipment industry.

This Insight Report provides a comprehensive analysis of the global Silver Sintering Die

Bonding Equipment landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyzes the strategies of leading global companies with a focus on Silver Sintering Die Bonding Equipment portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms' unique position in an accelerating global Silver Sintering Die Bonding Equipment market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for Silver Sintering Die Bonding Equipment and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Silver Sintering Die Bonding Equipment.

This report presents a comprehensive overview, market shares, and growth opportunities of Silver Sintering Die Bonding Equipment market by product type, application, key manufacturers and key regions and countries.

Segmentation by Type:

- Offline Sintering Equipment
- Inline Sintering Equipment
- Die Bonder With Sintering Function
- Others

Segmentation by Process Pressure:

- Pressure Silver Sintering Equipment
- Low-Pressure Silver Sintering Equipment
- Pressureless Silver Sintering Equipment

Others

Segmentation by Automation Level:

Fully Automatic Equipment

Semi-Automatic Equipment

Manual and Laboratory Equipment

Segmentation by End-Use Industry:

Electric Vehicle and Automotive Electronics

Industrial Power Electronics

Renewable Energy and Energy Storage

Others

Segmentation by Application:

SiC Power Module Packaging

IGBT Power Module Packaging

Discrete Power Device Packaging

Others

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

China

Japan

Korea

Southeast Asia

India

Australia

Europe

Germany

France

UK

Italy

Russia

Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analysing the company's coverage, product portfolio, its market penetration.

ASMPT Limited

Suzhou Bopai Semiconductor Technology Co., Ltd. (Boschman)

AMX Automatrix S.r.l.

PINK GmbH Thermosysteme

Nikkiso Co., Ltd.

Palomar Technologies, Inc.

BE Semiconductor Industries N.V.

Infotech AG

Tresky GmbH

Mycronic AB (MRSI Systems)

Zhuhai Silicon Cool Technology Co., Ltd.

Shenzhen Advanced Joining Technologies Co., Ltd.

Quick Intelligent Equipment Co., Ltd.

Chenglian Kaida (Hebei) Technology Co., Ltd.

JH Advanced Semiconductor (Suzhou) Co., Ltd.

Zhongke Guangzhi (Chongqing) Technology Co., Ltd.

Torch Semiconductor Co., Ltd.

CYG Semiconductor Equipment (Zhuhai) Co., Ltd.

Key Questions Addressed in this Report

What is the 10-year outlook for the global Silver Sintering Die Bonding Equipment market?

What factors are driving Silver Sintering Die Bonding Equipment market growth, globally and by region?

Which technologies are poised for the fastest growth by market and region?

How do Silver Sintering Die Bonding Equipment market opportunities vary by end market size?

How does Silver Sintering Die Bonding Equipment break out by Type, by Application?

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